

OSRAM KRTBLFLM71.32

Datasheet

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DISPLIX® P2828

KRTB LFLM71.32

This device is especially designed for full color video walls. The 6-lead-technology allows for an additive mixture of color stimuli by independent driving of each chip. Very compact package size fits best for high resolution video walls.



Applications

- Video Walls Signage
- VMS

Features

- Package: SMD epoxy package, higher contrast by a black surface (RGB-Displays)
- Chip technology: Thinfilm / InGaN on Sapphire
- Typ. Radiation: 110° (horizontal), 110° (vertical)
- Color: $\lambda_{\text{dom}} = 621 \text{ nm}$ (● red); $\lambda_{\text{dom}} = 525 \text{ nm}$ (● true green); $\lambda_{\text{dom}} = 472 \text{ nm}$ (● blue)
- ESD: 500 V acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 1B)

Ordering Information

Type	Brightness ¹⁾	Ordering Code
KRTBLFLM71.32-TZUV-GQ+VTVX-FM+RYSX-QW-B		Q65113A0738
• red	• $I_v = 424 \dots 710 \text{ mcd}$ ($I_F = 15 \text{ mA}$)	
• true green	• $I_v = 754 \dots 1250 \text{ mcd}$ ($I_F = 10 \text{ mA}$)	
• blue	• $I_v = 159 \dots 315 \text{ mcd}$ ($I_F = 10 \text{ mA}$)	

Maximum Ratings

Parameter	Symbol		Values	Values	Values
			● red	● true green	● blue
Operating Temperature	T_{op}	min.	-40 °C	-40 °C	-40 °C
		max.	85 °C	85 °C	85 °C
Storage Temperature	T_{stg}	min.	-40 °C	-40 °C	-40 °C
		max.	90 °C	90 °C	90 °C
Junction Temperature	T_j	max.	110 °C	110 °C	110 °C
Forward Current $T_s = 25\text{ °C}$; per chip	I_F	max.	20 mA	20 mA	20 mA
Forward Current pulsed $D = 0.005$; $t_p = 2.8\text{ ms}$ (red chip); $t_p = 5.8\text{ ms}$ (true green); $t_p = 3.3\text{ ms}$ (blue); $T_s = 25\text{ °C}$; per chip	$I_{F\text{ pulse}}$	max.	40 mA	40 mA	40 mA
Reverse voltage ²⁾ $T_s = 25\text{ °C}$; per chip	V_R	max.	5 V	5 V	5 V
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 1B)	V_{ESD}		500 V	500 V	500 V

Characteristics

IF = 15 mA (red chip); IF = 10 mA (true green and blue chip); TS = 25 °C

Parameter	Symbol		Values ● red	Values ● true green	Values ● blue
Peak Wavelength	λ_{peak}	typ.	630 nm	519 nm	468 nm
Dominant Wavelength ³⁾	λ_{dom}	min.	618 nm	521 nm	468 nm
		typ.	621 nm	525 nm	472 nm
		max.	626 nm	527 nm	474 nm
Viewing angle at 50% I _V values for 0°, 90°	2φ	typ.	110 °	110 °	110 °
		typ.	110 °	110 °	110 °
Forward Voltage ⁴⁾	V _F	min.	1.60 V	2.50 V	2.50 V
		typ.	2.10 V	2.70 V	3.00 V
		max.	2.60 V	3.50 V	3.50 V
Reverse current ²⁾ V _R = 10 V	I _R	max.	1 μA	1 μA	1 μA
		typ.	0.01 μA	0.01 μA	0.01 μA
Real thermal resistance junction/sol- derpoint ⁵⁾	R _{thJS real}	typ.	290 K / W	440 K / W	320 K / W
		max.	310 K / W	470 K / W	330 K / W

Brightness Groups

● red

Group	Luminous Intensity ¹⁾ $I_F = 15 \text{ mA}$ min. I_v	Luminous Intensity ¹⁾ $I_F = 15 \text{ mA}$ max. I_v
TZ	424 mcd	560 mcd
US	450 mcd	594 mcd
UT	474 mcd	630 mcd
UU	500 mcd	669 mcd
UV	529 mcd	710 mcd

Brightness Groups

● true green

Group	Luminous Intensity ¹⁾ $I_F = 10 \text{ mA}$ min. I_v	Luminous Intensity ¹⁾ $I_F = 10 \text{ mA}$ max. I_v
VT	754 mcd	1000 mcd
VU	800 mcd	1058 mcd
VV	849 mcd	1120 mcd
VW	900 mcd	1183 mcd
VX	949 mcd	1250 mcd

Brightness Groups

- blue

Group	Luminous Intensity ¹⁾ $I_F = 10 \text{ mA}$ min. I_v	Luminous Intensity ¹⁾ $I_F = 10 \text{ mA}$ max. I_v
RY	159 mcd	212 mcd
RZ	169 mcd	224 mcd
SS	180 mcd	237 mcd
ST	190 mcd	250 mcd
SU	201 mcd	265 mcd
SV	212 mcd	280 mcd
SW	224 mcd	297 mcd
SX	237 mcd	315 mcd

Wavelength Groups

- red

Group	Dominant Wavelength ³⁾	Dominant Wavelength ³⁾
	min. λ_{dom}	max. λ_{dom}
GQ	618 nm	626 nm

Wavelength Groups

- true green

Group	Dominant Wavelength ³⁾	Dominant Wavelength ³⁾
	min. λ_{dom}	max. λ_{dom}
FM	521 nm	527 nm

Wavelength Groups

- blue

Group	Dominant Wavelength ³⁾	Dominant Wavelength ³⁾
	min. λ_{dom}	max. λ_{dom}
QU	468 nm	472 nm
SW	470 nm	474 nm

Chromaticity Coordinate Groups

● red

Group	Cx	Cy
GQ	0.6696	0.3136
	0.6873	0.3126
	0.7022	0.2977
	0.6837	0.2995

Chromaticity Coordinate Groups

● true green

Group	Cx	Cy
FM	0.1479	0.7029
	0.1233	0.7520
	0.1551	0.7602
	0.1748	0.7131

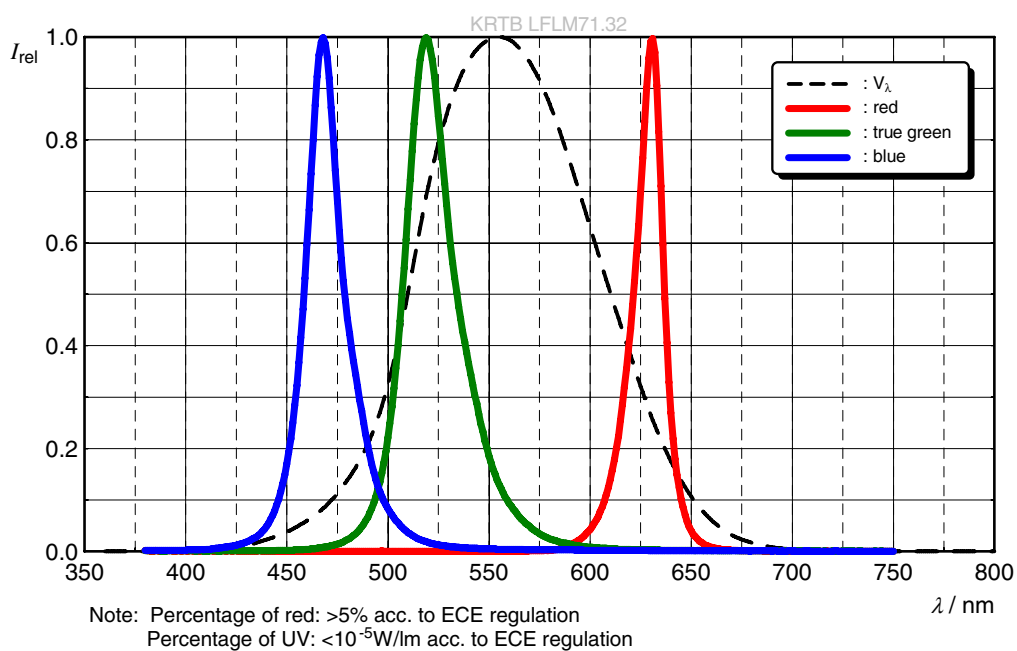
Chromaticity Coordinate Groups

● blue

Group	Cx	Cy
QU	0.1442	0.0705
	0.1315	0.0529
	0.1224	0.0723
	0.1357	0.0888
SW	0.1402	0.0790
	0.1273	0.0619
	0.1167	0.0845
	0.1304	0.1002

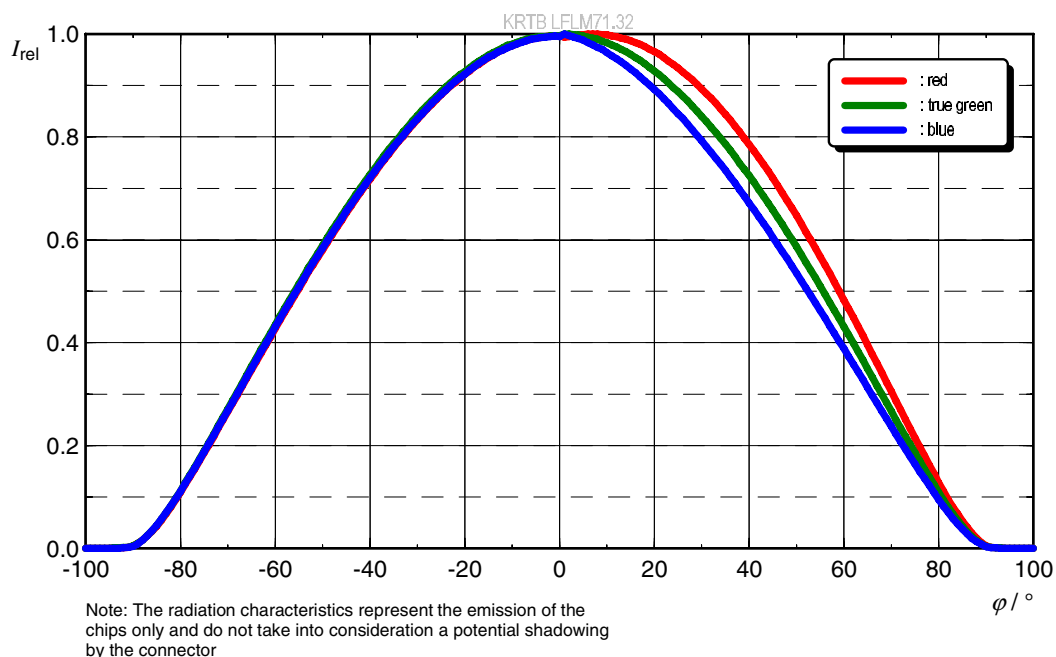
Relative Spectral Emission ⁶⁾

IF = 15 mA (red chip); IF = 10 mA (true green and blue chip); TS = 25 °C



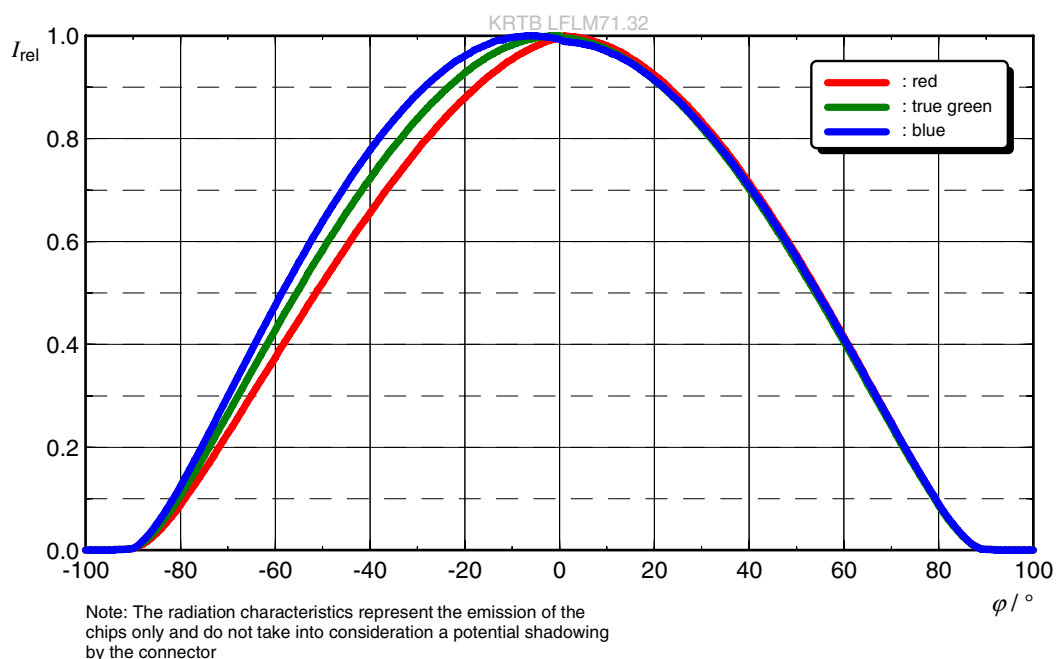
Radiation Characteristic (horizontal) ⁶⁾

IF = 15 mA (red chip); IF = 10 mA (true green and blue chip); TS = 25 °C



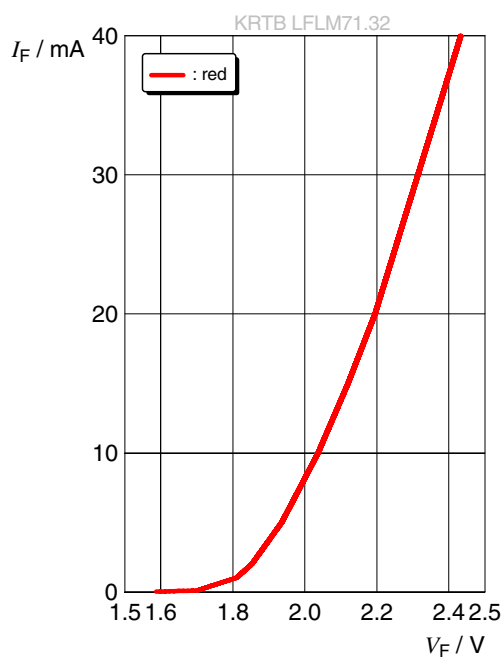
Radiation Characteristic (vertical) ⁶⁾

IF = 15 mA (red chip); IF = 10 mA (true green and blue chip); TS = 25 °C



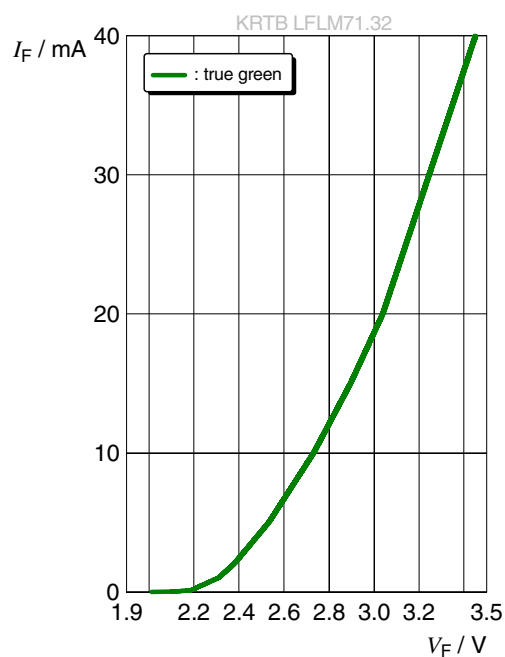
Forward current ⁶⁾

$$I_F = f(V_F); T_S = 25\text{ °C}$$



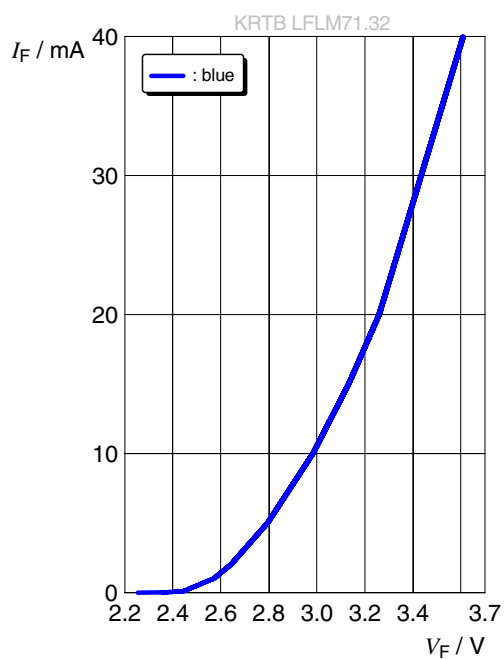
Forward current ⁶⁾

$$I_F = f(V_F); T_S = 25\text{ °C}$$



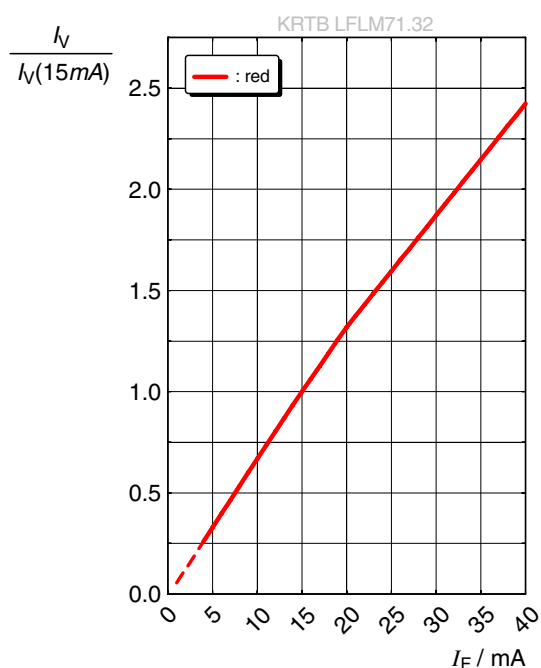
Forward current ⁶⁾

$$I_F = f(V_F); T_S = 25\text{ °C}$$



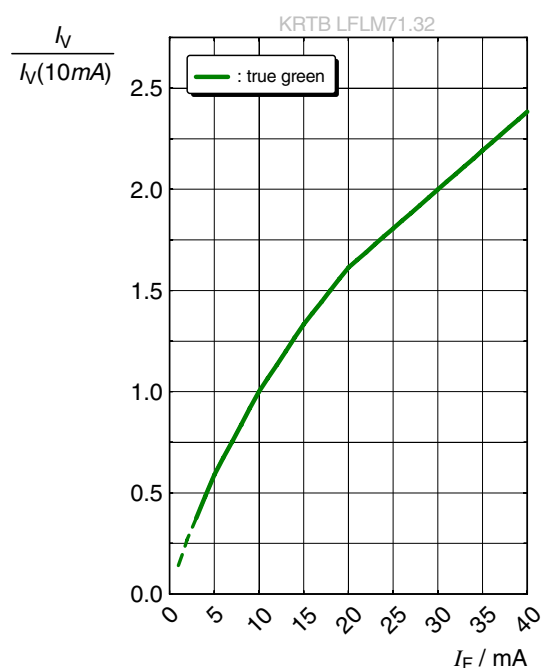
Relative Luminous Intensity ^{6), 7)}

$$I_V/I_V(15 \text{ mA}) = f(I_F); T_s = 25 \text{ °C}$$



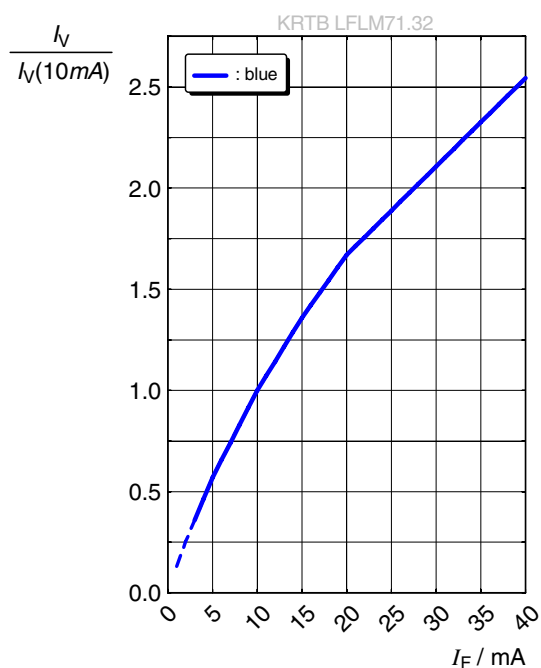
Relative Luminous Intensity ^{6), 7)}

$$I_V/I_V(10 \text{ mA}) = f(I_F); T_s = 25 \text{ °C}$$



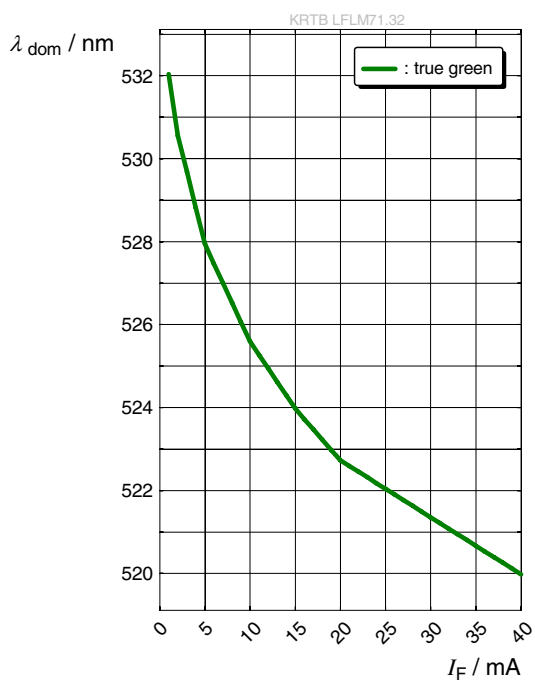
Relative Luminous Intensity ^{6), 7)}

$$I_V/I_V(10 \text{ mA}) = f(I_F); T_s = 25 \text{ °C}$$



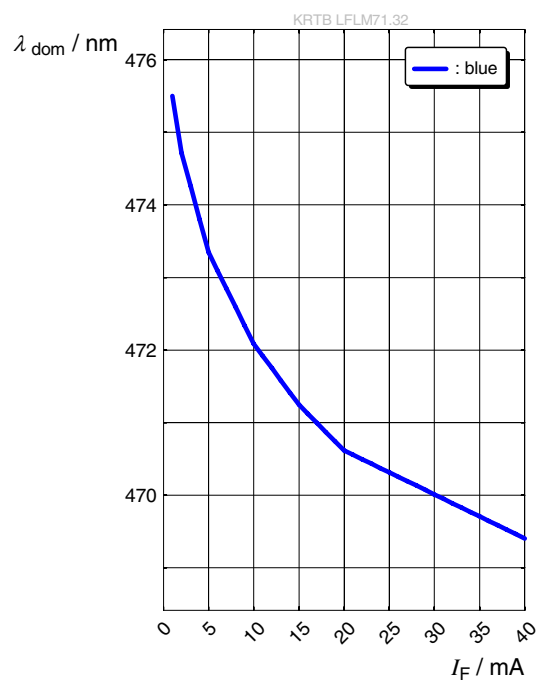
Dominant Wavelength ⁶⁾

$$\lambda_{\text{dom}} = f(I_F); T_S = 25\text{ °C}$$



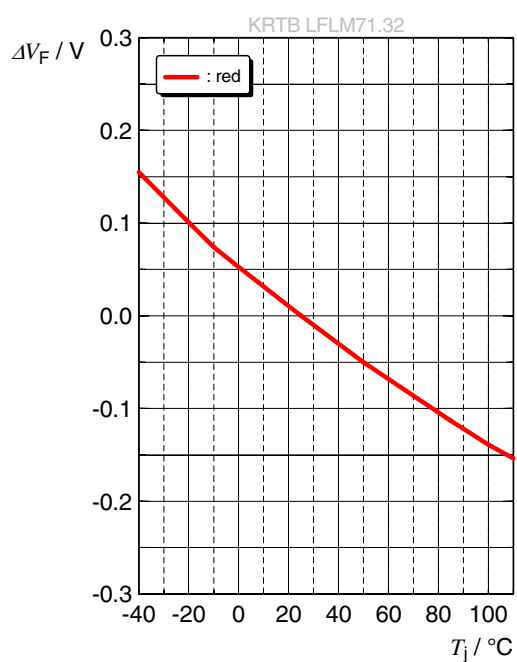
Dominant Wavelength ⁶⁾

$$\lambda_{\text{dom}} = f(I_F); T_S = 25\text{ °C}$$

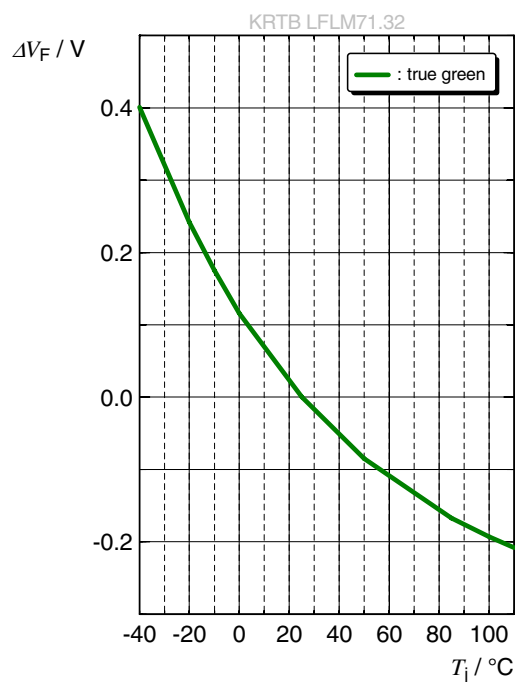


Forward Voltage ⁶⁾

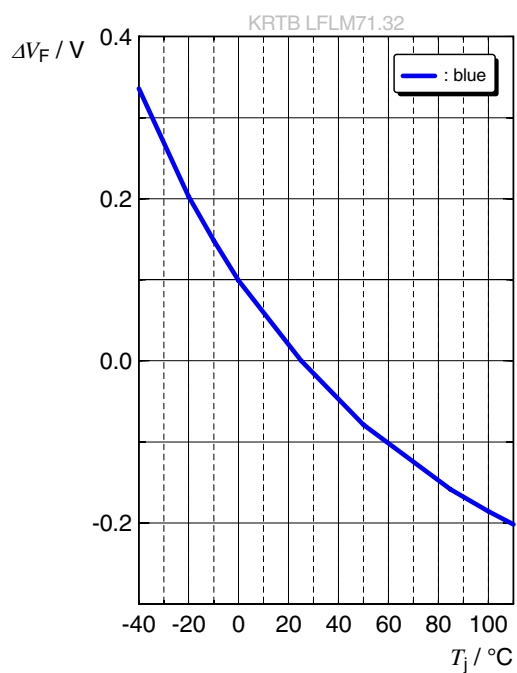
$$\Delta V_F = V_F - V_F(25\text{ °C}) = f(T_j); I_F = 15\text{ mA}$$

**Forward Voltage** ⁶⁾

$$\Delta V_F = V_F - V_F(25\text{ °C}) = f(T_j); I_F = 10\text{ mA}$$

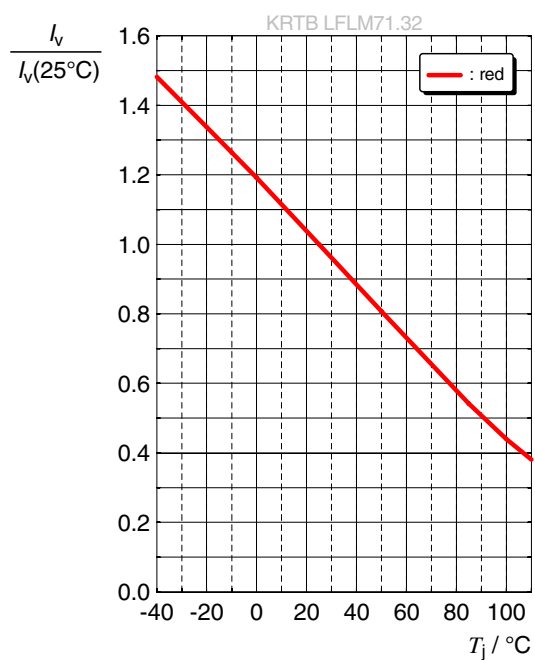
**Forward Voltage** ⁶⁾

$$\Delta V_F = V_F - V_F(25\text{ °C}) = f(T_j); I_F = 10\text{ mA}$$

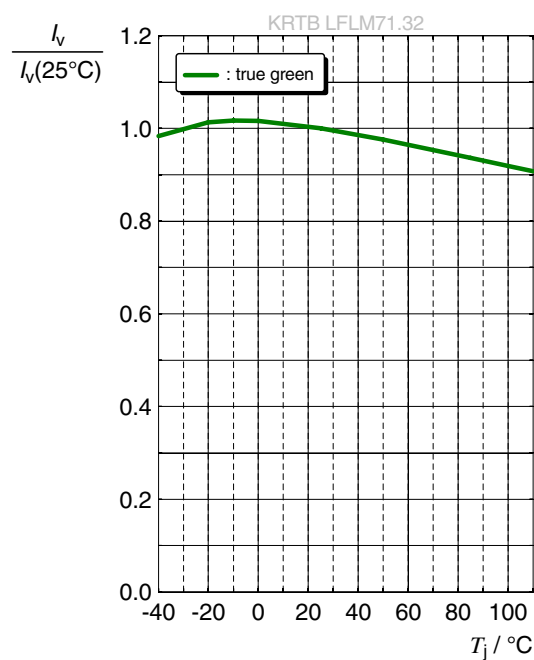


Relative Luminous Intensity ⁶⁾

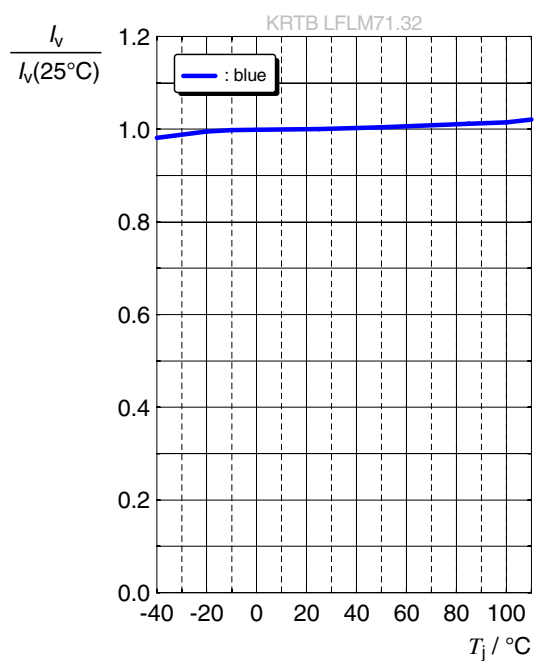
$$I_V/I_V(25\text{ °C}) = f(T_j); I_F = 15\text{ mA}$$

**Relative Luminous Intensity** ⁶⁾

$$I_V/I_V(25\text{ °C}) = f(T_j); I_F = 10\text{ mA}$$

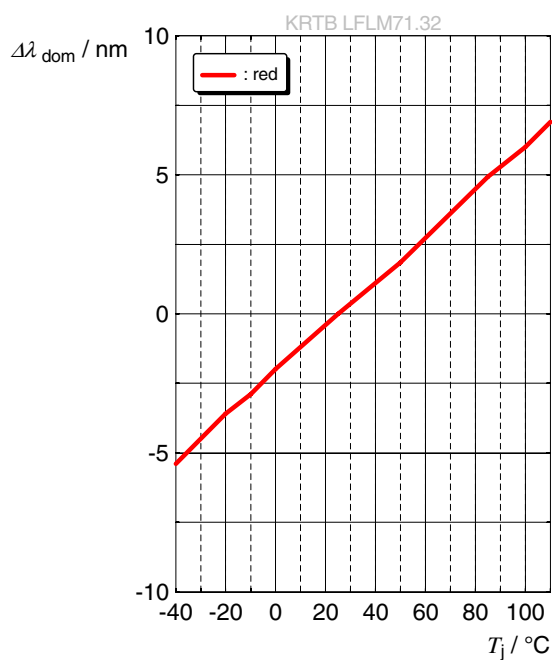
**Relative Luminous Intensity** ⁶⁾

$$I_V/I_V(25\text{ °C}) = f(T_j); I_F = 10\text{ mA}$$

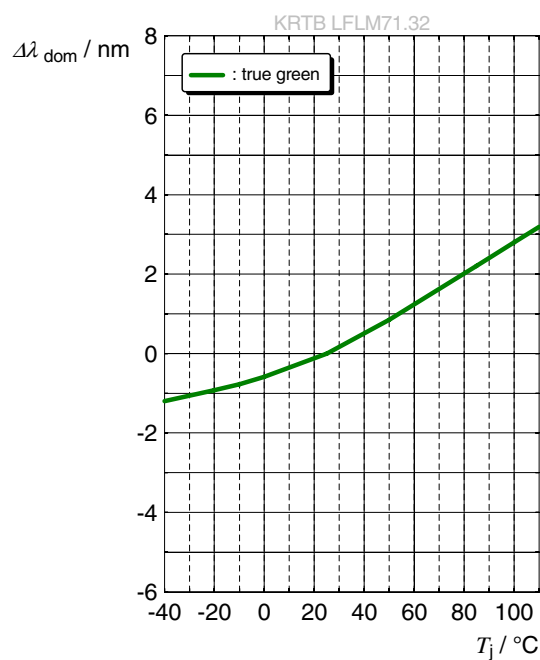


Dominant Wavelength ⁶⁾

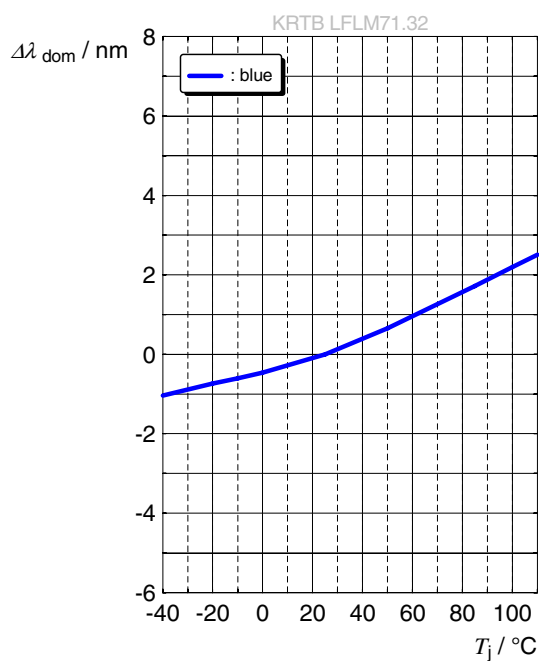
$$\Delta\lambda_{\text{dom}} = \lambda_{\text{dom}} - \lambda_{\text{dom}}(25\text{ °C}) = f(T_j); I_F = 15\text{ mA}$$

**Dominant Wavelength** ⁶⁾

$$\Delta\lambda_{\text{dom}} = \lambda_{\text{dom}} - \lambda_{\text{dom}}(25\text{ °C}) = f(T_j); I_F = 10\text{ mA}$$

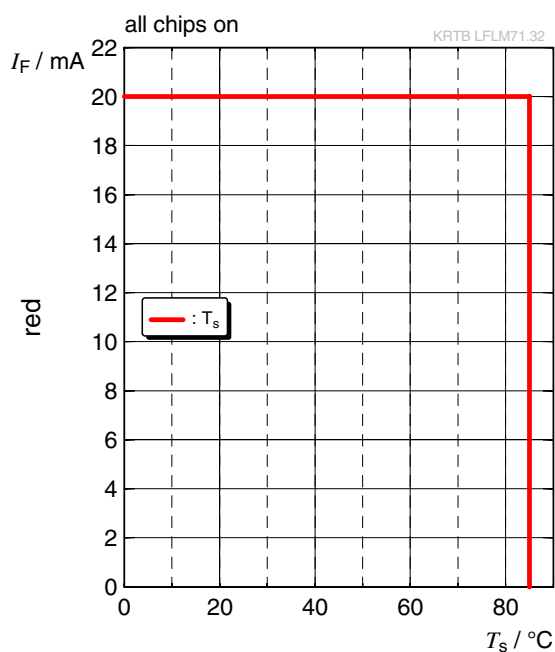
**Dominant Wavelength** ⁶⁾

$$\Delta\lambda_{\text{dom}} = \lambda_{\text{dom}} - \lambda_{\text{dom}}(25\text{ °C}) = f(T_j); I_F = 10\text{ mA}$$



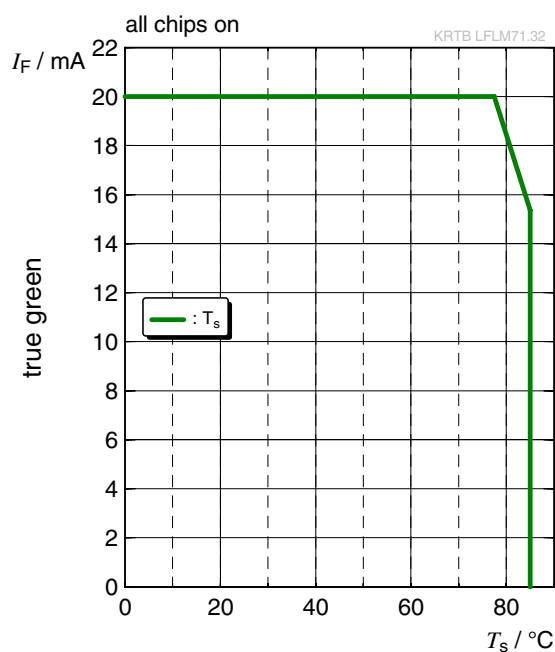
Max. Permissible Forward Current

$I_F = f(T)$; • red



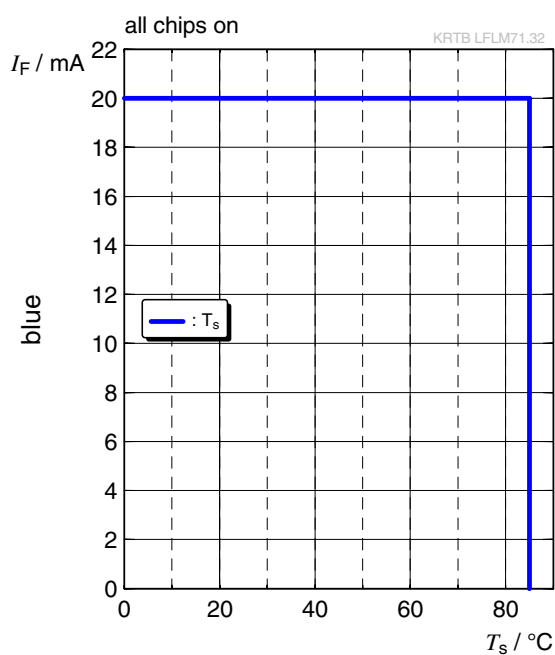
Max. Permissible Forward Current

$I_F = f(T)$; • true green



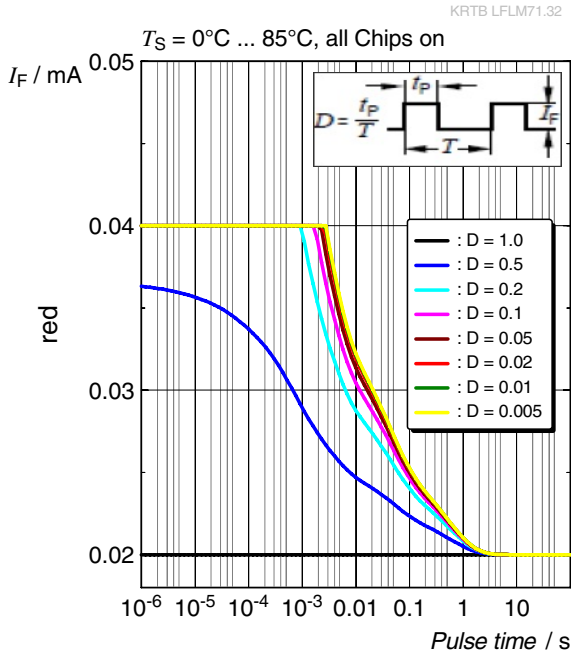
Max. Permissible Forward Current

$I_F = f(T)$; • blue



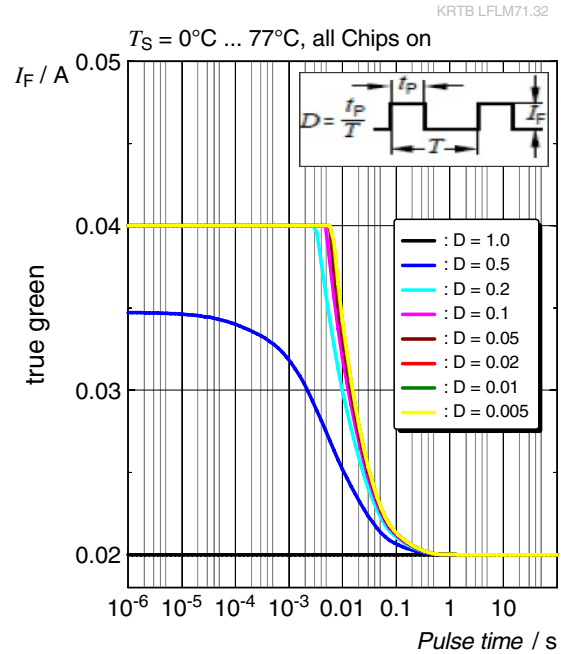
Permissible Pulse Handling Capability

$I_F = f(t_p)$; D: Duty cycle;
 $T_S = 0^\circ\text{C} \dots 85^\circ\text{C}$; ● red



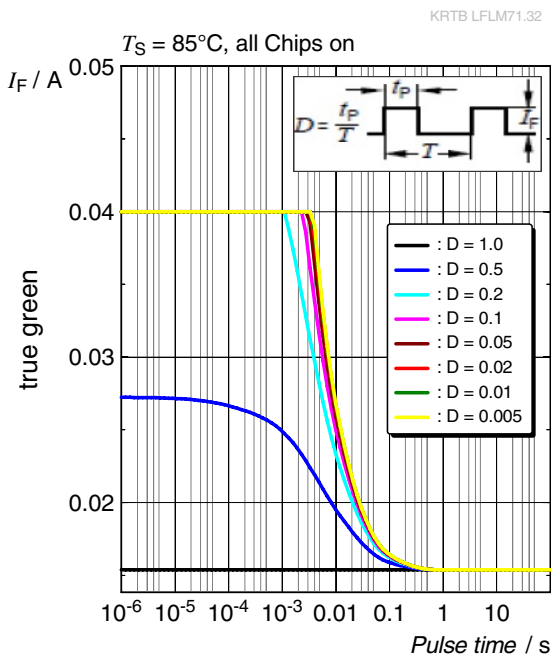
Permissible Pulse Handling Capability

$I_F = f(t_p)$; D: Duty cycle;
 $T_S = 0^\circ\text{C} \dots 77^\circ\text{C}$; ● true green



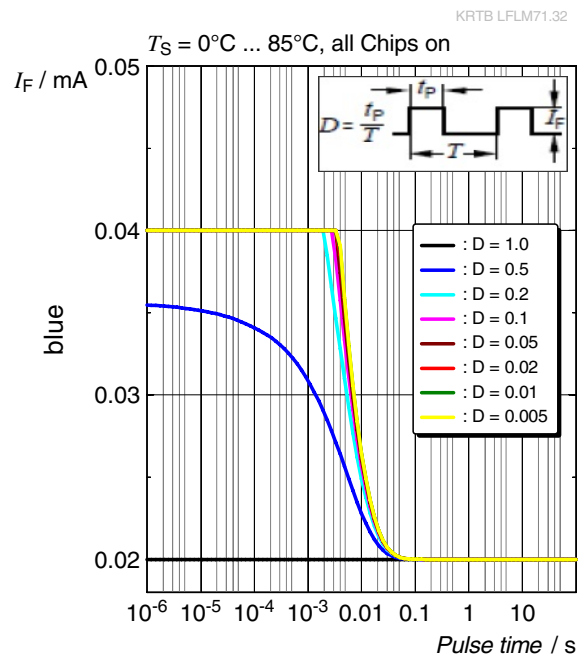
Permissible Pulse Handling Capability

$I_F = f(t_p)$; D: Duty cycle;
 $T_S = 85^\circ\text{C}$; ● true green

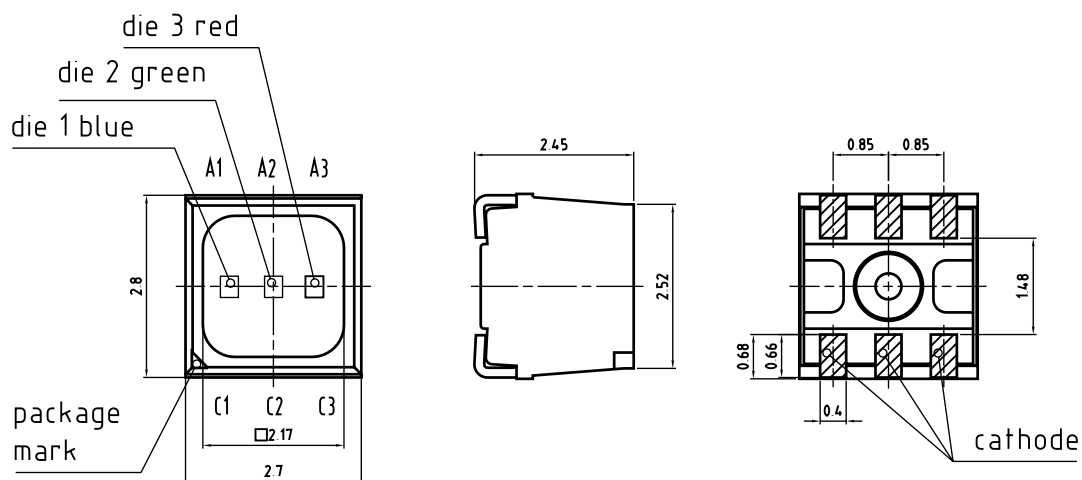


Permissible Pulse Handling Capability

$I_F = f(t_p)$; D: Duty cycle;
 $T_S = 0^\circ\text{C} \dots 85^\circ\text{C}$; ● blue



Dimensional Drawing ⁸⁾



general tolerance ± 0.1
lead finish Ag

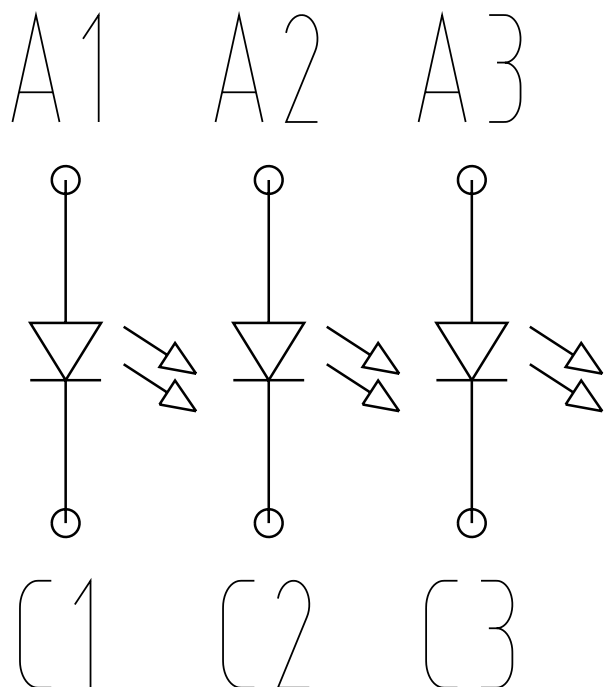
C63062-A4379-A1-01

Further Information:

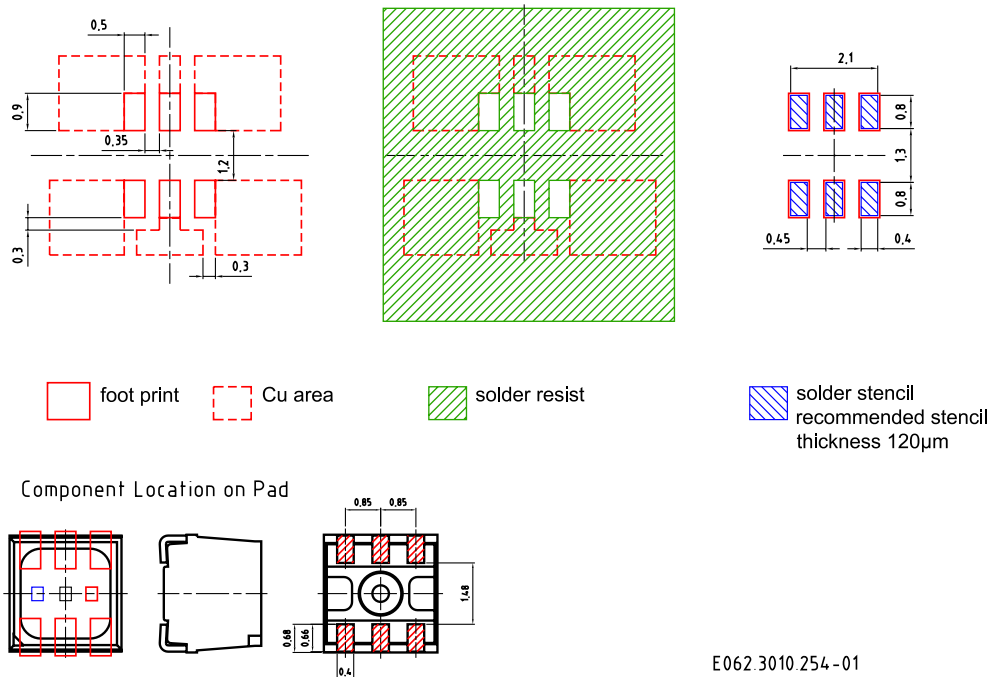
Approximate Weight: 7.5 mg

Package marking: Cathode

Electrical Internal Circuit



Recommended Solder Pad ⁸⁾

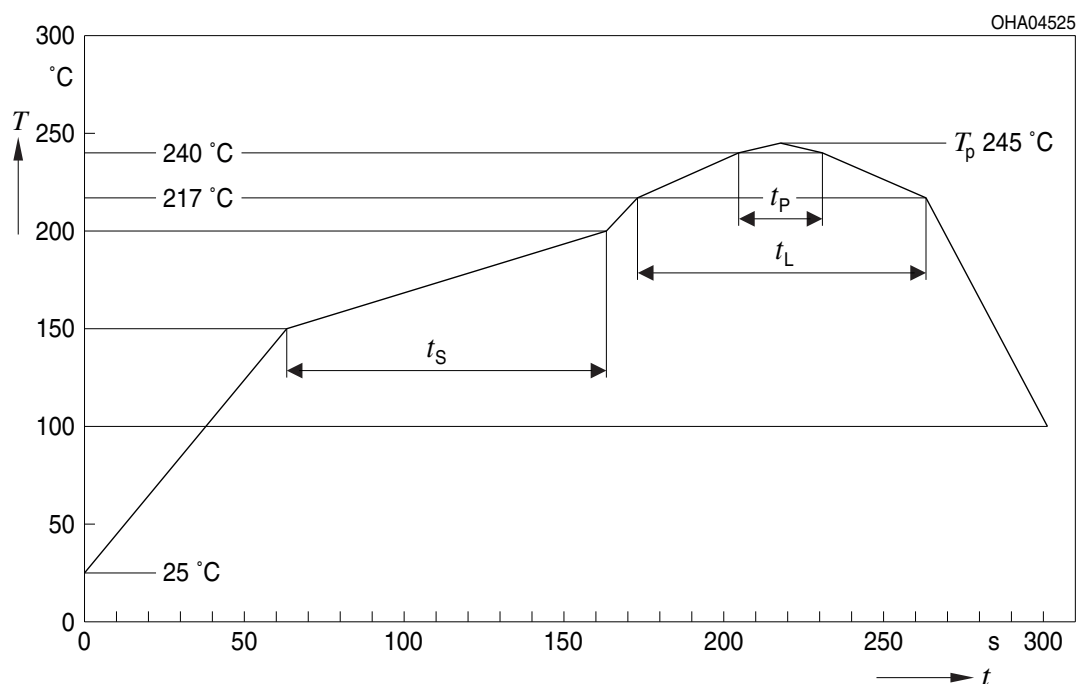


E062.3010.254-01

For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for ultra sonic cleaning.

Reflow Soldering Profile

Product complies to MSL Level 4 acc. to JEDEC J-STD-020E

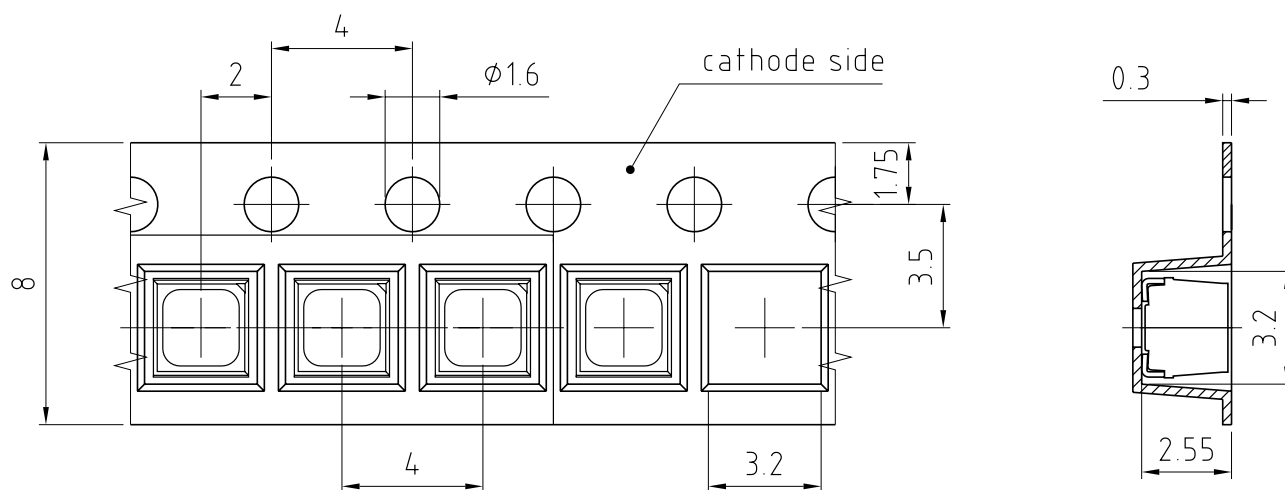


Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat ^{*)} 25 °C to 150 °C			2	3	K/s
Time t_s T_{Smin} to T_{Smax}	t_s	60	100	120	s
Ramp-up rate to peak ^{*)} T_{Smax} to T_p			2	3	K/s
Liquidus temperature	T_L		217		$^{\circ}\text{C}$
Time above liquidus temperature	t_L		80	100	s
Peak temperature	T_p		245	260	$^{\circ}\text{C}$
Time within 5 °C of the specified peak temperature $T_p - 5\text{ K}$	t_p	10	20	30	s
Ramp-down rate* T_p to 100 °C			3	6	K/s
Time 25 °C to T_p				480	s

All temperatures refer to the center of the package, measured on the top of the component

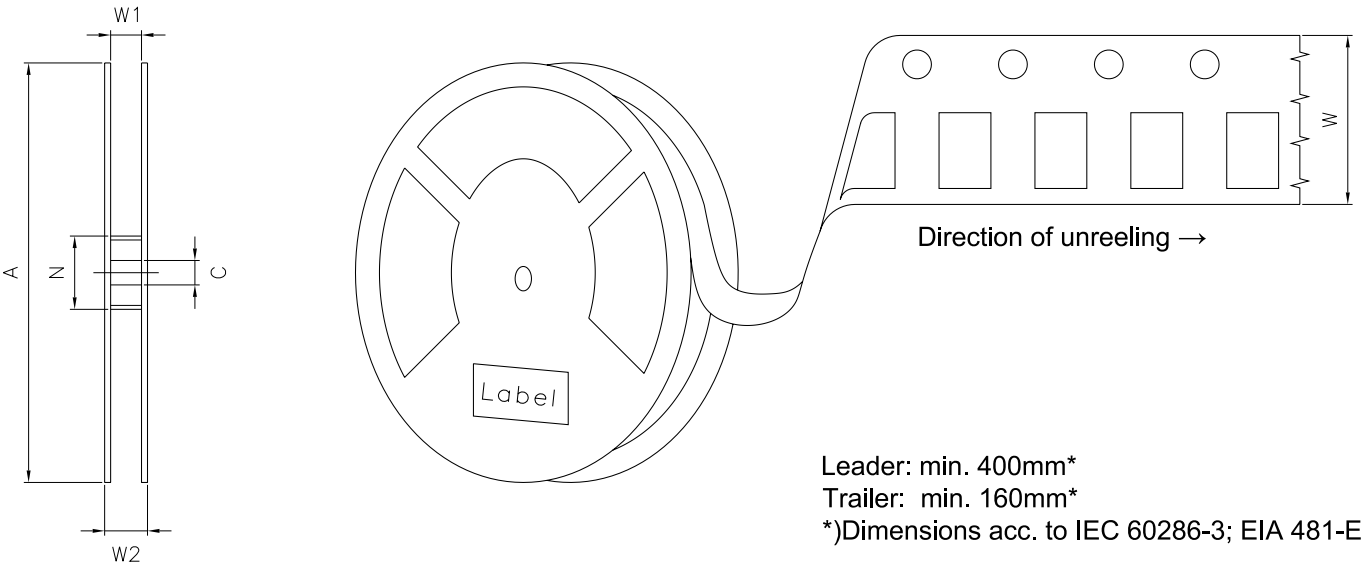
* slope calculation DT/Dt : Dt max. 5 s; fulfillment for the whole T-range

Taping ⁸⁾



C63062-A4379-B1-03

Tape and Reel ⁹⁾



Reel Dimensions

A	W	N _{min}	W ₁	W _{2 max}	Pieces per PU
355.6 mm	8 + 0.3 / - 0.1 mm	79.3 mm	8.7 + 0.3 mm	14.4 mm	8000

Barcode-Product-Label (BPL)

OSRAM Opto Semiconductors

LX XXXX
BIN1: XX-XX-X-XXX-X

RoHS Compliant

(6P) BATCH NO: 1234567890

(1T) LOT NO: 1234567890

(9D) D/C: 1234

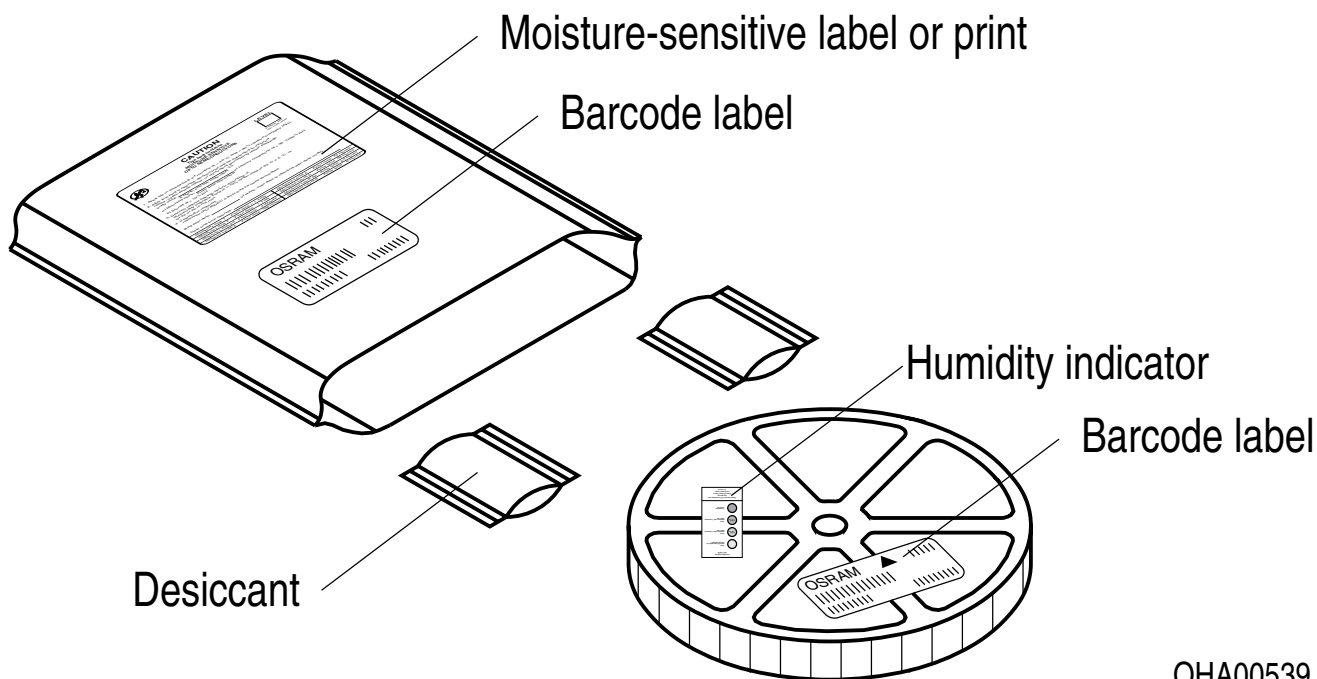
ML Temp ST
X XXX °C X

Pack: RXX
DEMY XXX
X_X123_1234.1234 X

(X) PROD NO: 123456789(Q)QTY: 9999 (G) GROUP: XX-XX-X-X

OHA04563

Dry Packing Process and Materials ⁸⁾



OHA00539

Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet fall into the class **exempt group (exposure time 10000 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

Changes to the content of this datasheet may occur without further notification. JEDEC 46C constitutes the guideline of the change management for the device specified in this document.

For further application related information please visit www.osram-os.com/appnotes

Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on our website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

Our components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

Our products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using our components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform our local sales partner immediately and we and buyer and /or customer will analyze and coordinate the customer-specific request between us and buyer and/or customer.

Glossary

- 1) **Brightness:** Brightness groups are tested at a current pulse duration of 25 ms and a tolerance of $\pm 11\%$.
- 2) **Reverse Operation:** This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.
- 3) **Wavelength:** Wavelengths are tested at a current pulse duration of 25 ms and a tolerance of ± 1 nm.
- 4) **Forward Voltage:** Forward voltages are tested at a current pulse duration of 1 ms and a tolerance of ± 0.1 V.
- 5) **Thermal Resistance:** $R_{th\ max}$ is based on statistic values (6σ).
- 6) **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- 7) **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- 8) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ± 0.1 and dimensions are specified in mm.
- 9) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

Revision History

Version	Date	Change
1.0	2019-04-12	Initial Version
1.1	2020-05-06	Schematic Transportation Box Dimensions of Transportation Box Ordering Information Maximum Ratings Brightness Groups Wavelength Groups New Layout Chromaticity Coordinate Groups Characteristics
1.2	2020-07-28	Brightness and Wavelength Groups
1.3	2022-05-31	Characteristics Electro - Optical Characteristics (Diagrams) Derating (Diagrams) New Layout



EU RoHS and China RoHS compliant product

此产品符合欧盟 RoHS 指令的要求；
按照中国的相关法规和标准，
不含有毒有害物质或元素。

Published by ams-OSRAM AG

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